

# Low-voltage-drop LED driver board up to 36.5 mA

## **About this document**

#### **Scope and purpose**

This document presents an evaluation board design for a linear and low-voltage-drop LED driver based on an Infineon BCR431U driver IC. It is an engineering report on features and performance for a 24 V/36.5 mA (max. LED current) solution, with explanations covering circuit and layout design.

BCR431U is a linear LED driver IC in a small PG-SOT23-6 package regulating the LED current in standalone operation without any external power transistor.

#### **Intended audience**

This document is intended for design engineers, application engineers and students, for example, who need to design low-cost, highly reliable linear LED drivers for:

- LED strips
- LED displays and channel letters
- Architectural and landscape lighting
- Retail lighting

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#### Introduction 1

This is an engineering report for a 24 V, 36.5 mA linear LED driver evaluation board. This document contains the technical specification for the LED driver, a description of the main features, and circuit and layout descriptions, as well as the measurement results.

In this application, an Infineon BCR431U is used as an LED driver IC. It regulates the LED current in standalone operation without any external power transistor. The LED current level can be adjusted up to 36.5 mA by connecting a high-ohmic resistor Rset to pin RS. The default LED current is set to 15 mA with an Rset of 60.4 k $\Omega$ . The voltage drop at the integrated LED driver stage can typically go down to 80 mV (refer to LED current vs. voltage on LED pin), improving the overall system efficiency and providing extra voltage headroom to compensate for tolerances of LED forward voltage or supply voltage. A smart over-temperature protection function reduces the LED current when the junction temperature of BCR431U is very high.

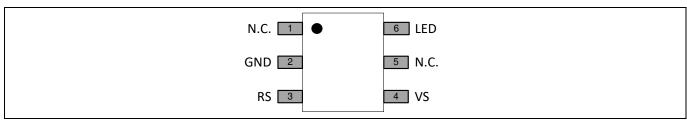
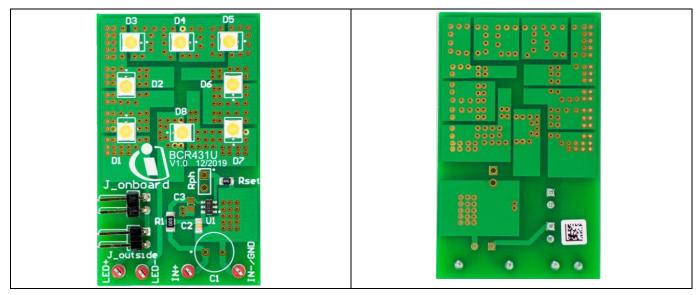


Figure 1 **BCR431U pin definition** 



Top and bottom side of the reference design board (55.1 mm x 33.7 mm) Figure 2

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**Technical specification** 

# 2 Technical specification

# Table 1 Technical specification

Input voltage	24 V
Default Rset	60.4 kΩ
Default LED current	15 mA
Rset range	114 kΩ to 24.9 kΩ
LED current range	8 mA to 36.5 mA
On-board LED number	8 LEDs in series
Device dimensions	55.1 mm x 33.7 mm (L x W)

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List of product features

# 3 List of product features

#### Table 2 List of IC features

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Supply voltage from 6 V to 42 V		
Controls up to 36.5 mA LED current		
Typical 80 mV saturation voltage at 15 mA		
LED current precision ±10 percent		
Smart over-temperature protection function vs. junction temperature		



**Circuit description** 

#### **Circuit description** 4

#### 4.1 **Circuit diagram**

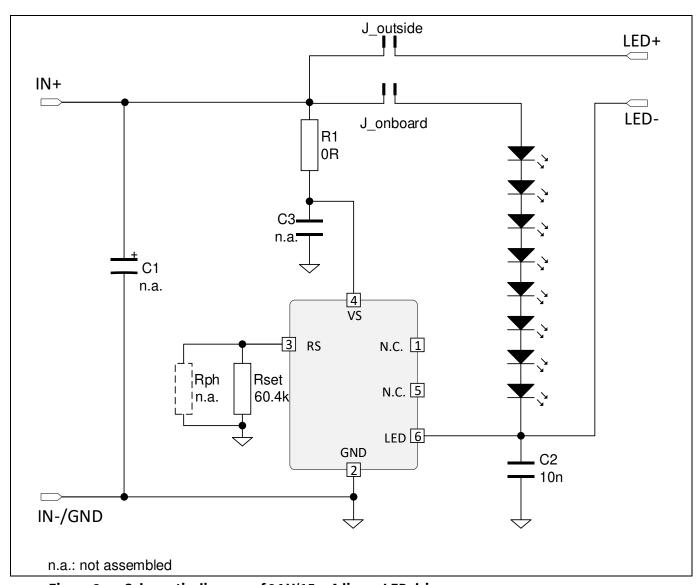


Figure 3 Schematic diagram of 24 V/15 mA linear LED driver

C1, C3 and Rph are not assembled.

C1 is a "placeholder" of an electrolytic capacitor. In case of power-supply output voltage ripple, an electrolytic capacitor can be assembled to suppress the ripple.

R1 and C3 can be assembled as high-frequency noise filters if needed for power-supply connection.

A 10 nF bypass capacitor C2 connected between LED pin 6 and GND reduces the risk of oscillation at the LED pin. C2 needs to be placed close to LED pin 6.

R1 can be replaced by a multimeter connection in order to measure the IC current Is. Rph is a "placeholder" for a two-pin through-hole footprint of 2.54 mm. It allows for the option of soldering a variable resistor, a header or a through-hole resistor to the board.

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**Circuit description** 

#### Configuration 4.2

24 V DC source is supplied to ports IN+ and IN-/GND. By default, a jumper is placed on header J\_onboard, so that the on-board LED string is used as the load. If an external LED load is desired, it can be connected to ports LED+ and LED-, and it can be selected as the load by removing the jump from header J\_onboard and placing a jump on header J\_outside.

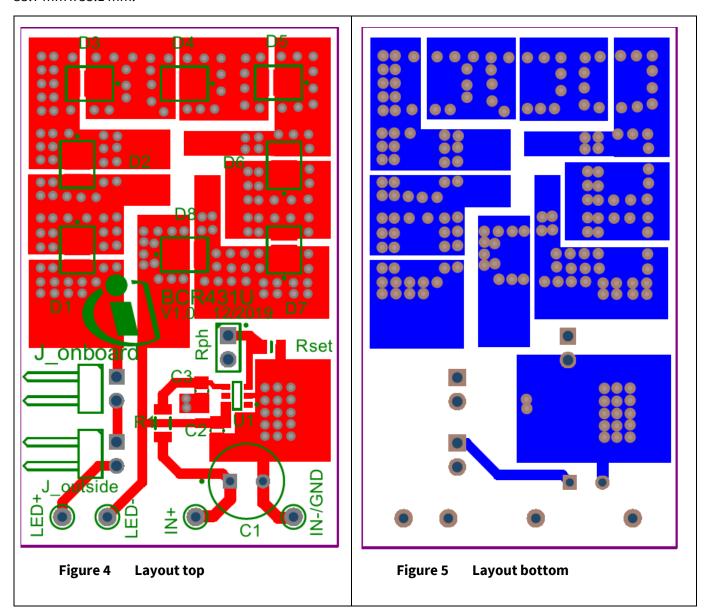
By default, Rset is 60.4 k $\Omega$ , which configures the LED current to be 15 mA. The LED current level can be adjusted by placing different Rset resistances (please refer to the BCR431U datasheet for more detail).





# 5 PCB layout

The PCB is double-sided and is manufactured with the standard 1.5 mm thickness and 1 oz. copper. It measures 33.7 mm x 55.1 mm.



For heat dissipation on BCR431U, it is recommended to connect copper areas that act as heat spreaders to the GND pin. LEDs also require large copper areas and vias for heat dissipation.

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# 6 Bill of Materials (BOM)

## Table 3 BOM

Component designator	Description	Manufacturer	Manufacturer part number
C2	Ceramic capacitor, 10 nF, 50 V, X7R		Standard capacitor
D1, D2, D3, D4, D5, D6, D7, D8	White LEDs with $V_F$ approx. 2.8 V at 50 mA at $T_j = 25$ °C	Lumileds	MXA9-PW65-H001
J_onboard, J_outside	Through-hole header, 2.54 mm pitch, two pins, right angle	Würth Elektronik	61300211021
J_jump Jumper sockets, placed on top of J_onboard		3M	969102-0000-DA
R1	Resistor, 0 Ω, 1 percent, 1206		Standard resistor
Rset Resistor, $60.4 \text{ k}\Omega$ , 1 percent, $0805$			Standard resistor
U1 BCR431U, SOT23-6		Infineon	SP005351261





## 7 Test results

## 7.1 Ambient temperature (T<sub>A</sub>) from -40°C to 125°C

Smart over-temperature protection is implemented inside BCR431U, which reduces the LED current at high junction temperatures in order to prevent a "thermal runaway". In this section, voltages at pins RS and LED and LED current are measured at different temperatures.

#### Test procedure:

- 1. Rset =  $60.4 \text{ k}\Omega$ .
- 2. Place the board inside the temperature chamber.
- 3. Set the chamber temperature to -40°C, and ramp up to 125°C.
- 4. Measure the voltages on the RS pin (V<sub>RS</sub>) and LED pin (V<sub>LED</sub>), and LED current (I<sub>LED</sub>).

Note: Due to its temperature coefficient, the Rset resistance value changes with respect to temperature.

#### 7.1.1 On-board LEDs as the load

A key advantage of BCR431U is the low driver saturation voltage ( $V_{LED,sat}$ ), which provides extra headroom for tolerances of supply voltage and LED forward voltage and also results in a small power dissipation inside BCR431U. In this measurement input voltage  $V_{IN}$  is reduced to 21.5 V in order to drive the voltage at the LED pin at -40°C, close to the saturation voltage of BCR431U (**Figure 7** and **Figure 8**).

Note: The on-board LEDs are not specified for 125°C ambient temperature.

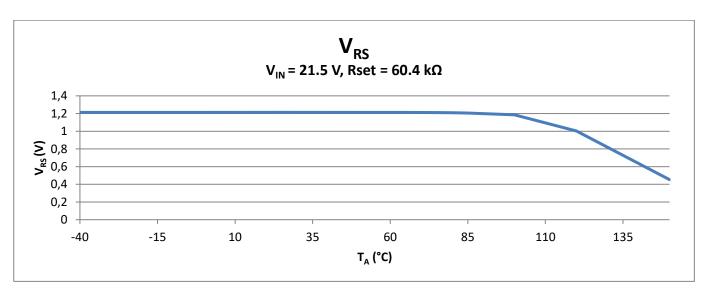


Figure 6 Voltage on the RS pin vs. T<sub>A</sub>

# infineon

**Test results** 

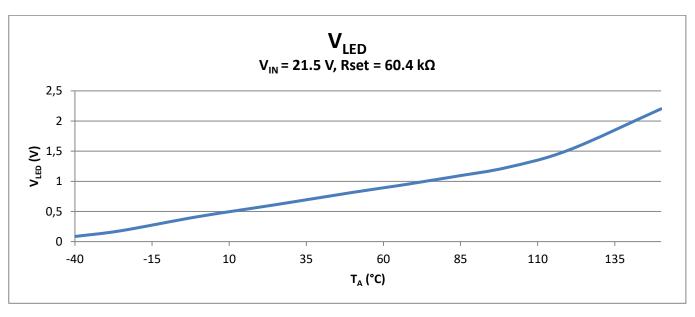


Figure 7 Voltage on the LED pin vs. T<sub>A</sub>

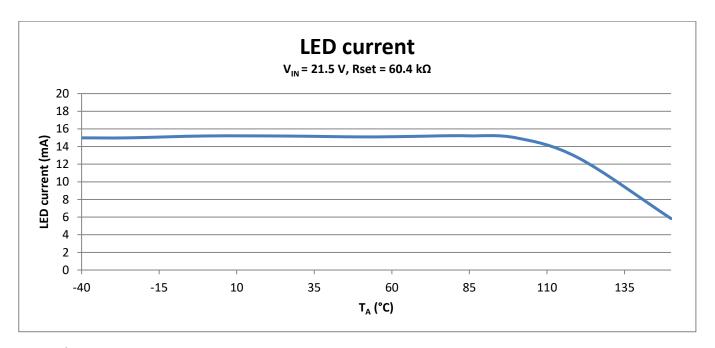


Figure 8 LED current vs. T<sub>A</sub>

It can be seen from **Figure 6** and **Figure 8** that when the ambient temperature rises above 100°C, the over-temperature protection function starts, reducing the LED current.

#### 7.2 More measurements

The following measurements are done at room temperature (unless otherwise specified). The data is recorded when the board runs for 30 minutes and reaches thermal stability, except **Figure 10**.

**Figure 9** shows the LED current measured at 0 (i.e. immediately LEDs are on), 10, 20 and 30 minutes. In the beginning, the IC is at room temperature. Over time the IC temperature increases until it reaches thermal stability. Due to the positive temperature coefficient of the LED current below activation of the over-

V 1.0



**Test results** 

temperature protection (refer to **Figure 9**), the LED current increases slightly until the IC reaches thermal stability.

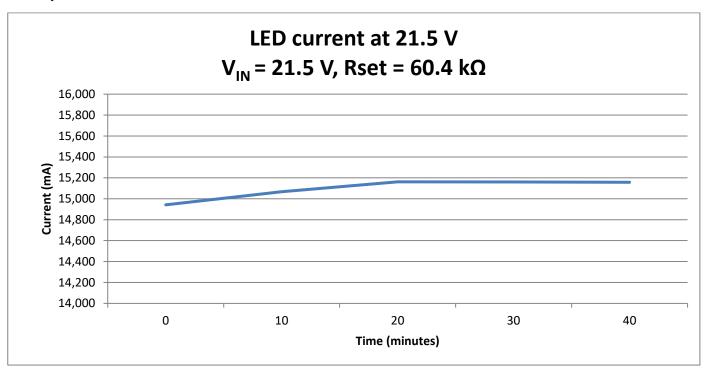


Figure 9 LED current vs. running time

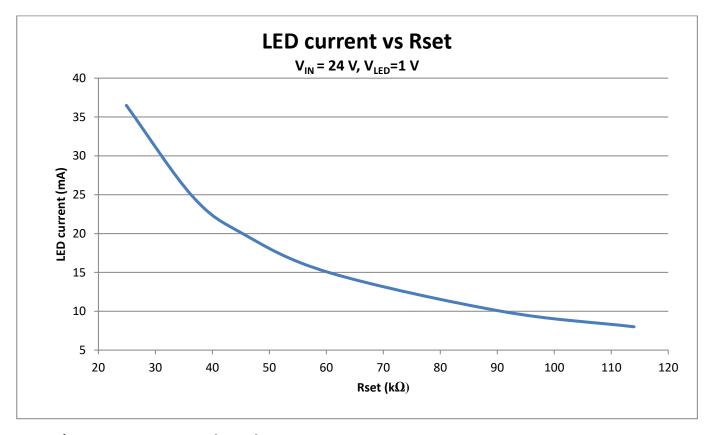


Figure 10 LED current dependency on Rset



**Test results** 

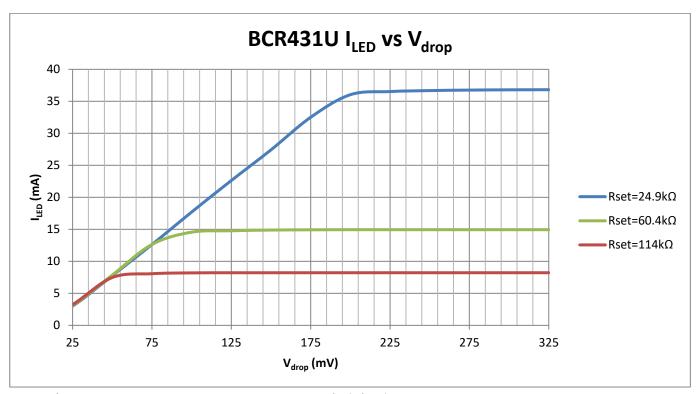


Figure 11 LED current vs. voltage on LED pin (pin 6)

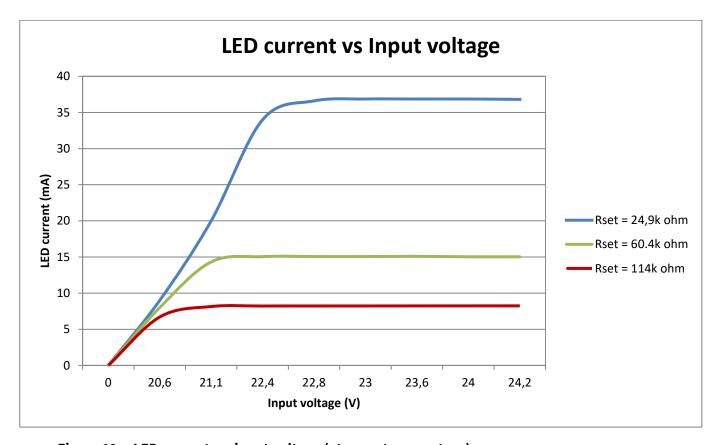


Figure 12 LED current vs. input voltage (at room temperature)

**Figure 11** shows the relationship between LED current  $I_{LED}$  and the voltage  $V_{LED}$  at pin 6 for three different values of resistor Rset.

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#### **Test results**

**Figure 12** shows the relationship between LED current  $I_{LED}$  and the evaluation board input voltage  $V_{IN}$  for three different values of resistor Rset. Due to the increase in the LED forward voltage with increasing LED current, the  $V_{IN}$  voltage sweep is wider than in Figure 11 until a constant LED current is reached.



Figure 13 Thermal photo ( $V_{IN}$  = 24 V, Rset = 60.4 k $\Omega$ ,  $I_{LED}$  = 15 mA,  $T_A$  = 25°C)

**Figure 13** shows the thermal photo of the board (portion). BCR431U is located in the rectangle, with a case temperature of 31.7°C.

# Low-voltage-drop LED driver board up to 36.5 mA



**Revision history** 

# **8** Revision history

Document version	Date of release	Description of changes
V 1.0	2020-03-20	First release

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